

<b>FORM PTO-1449</b>  <b>INFORMATION DISCLOSURE CITATION</b>				<b>Attorney Docket:</b> 4024-4044US2		<b>Serial No.:</b> To Be Assigned	
				<b>Applicant:</b> John Trezza			
				<b>Filing Date:</b> September 30, 2003		<b>Group Art Unit:</b> To Be Assigned	
<b>U.S. PATENT DOCUMENTS</b>							
Examiner Initial	Patent Number	Publication Date	Name	Class	Sub-Class	Filing Date	
DW	4,533,833	August 6, 1985	Copeland et al.			August 19, 1982	
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✓	5,912,997	June 15, 1999	Bischel et al.			June 16, 1998	
<b>Examiner</b>				<b>Date Considered</b> 8/15/05			
<b>EXAMINER:</b> Initial if reference considered, whether or not citation is in conformance with MPEP §609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to Applicant.							

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Examiner Initial	Patent Number	Publication Date	Country	Class	Sub-Class	Translation
						<input type="checkbox"/> Yes <input type="checkbox"/> No
						<input type="checkbox"/> Yes <input type="checkbox"/> No
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Examiner	Date Considered 8/15/05
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